

Reliability Qualification Report

for

LPSDR SDRAM with Pb/Halogen Free (Industrial)

(8M×16, 45nm SDRAM AS4C8M16MSB-6BIN)



Contents :

- 1. Title
- 2. Product and Package Information
- 3. Result Summary
- 4. Accelerated Lifetime Simulation Tests (Including Failure Rate Estimation)
- **5. Accelerated Environment Stress Tests**
- 6. Electrical Verification Tests (Electrostatic Discharge & Latch-up)



1. Title

This report describes the reliability and qualification data of Alliance product listed below. The reliability tests have been completed successfully based on Alliance standard.

2. Product and Package Information

Product Code Product Description Operating Temperature Range Operating Voltage Package Type Flammability :AS4C8M16MSB-6BIN : 128Mb LPSDR : -40°C to +85°C : VDD/VDDQ 1.7~1.95V : FBGA 54B (8.0x8.0mm, 1.0T) : UL-V0



3. Result Summary

Process Results Lifetime Simulation Tests Environment Stress Tests Environment Compliance : Pass All Items

- : Pass ELFR & HTOL
- : Pass All Tests
- : Meet All Items



4. Accelerated Lifetime Simulation Tests

| Group | Test Item / Conditions | Test Method | Duration or Level | Result | | |
|---------------------------------------|---|----------------|----------------------|-------------------|------------------------------|-------|
| | | | | Number of Lots | Failed Q'ty / Tested Q'ty | Notes |
| Accelerated Lifetime Simulation Tests | Early Life Failure Rate 125°C, VDD/VDDQ/VPP Dynamic stress | JESD22-A108 | 48 hours | 1 | 0 / 2300 (Pass) | 1, 2 |
| | High Temperature Operating Life 125°C, VDD/VDDQ/VPP Dynamic stress | JESD22-A108 | 1008 hours | 1 | 0 / 231 (Pass) | 1, 2 |
| Note : | | | | | | |

1) Electrical test is performed before and after each item.

2) "Dynamic stress" means continuous memory operation like read or write function.

* Failure Rate Estimation

Estimation Condition :

| User Operating Temperature : 55°C | | | | | |
|-----------------------------------|------------------|--|--|--|--|
| User Operating Voltage | : Typical VPP | | | | |
| Operating Voltage | : VDD/VDDQ & VPP | | | | |
| Confidence Level | : 60% | | | | |

$AF_{OVERALL} = AF_T * AF_V = 22.5 * 7.92 = 178$ Early Life (Ea = 0.5 eV, β = 6.9) : 46.6 FITs

Inherent Life (Ea = 0.5 eV, β = 6.9) : 17.0 FITs



5. Accelerated Environment Stress Tests

| Group | Test Item / Conditions | Test Method | Duration or Level | Result | | |
|--------------------------------------|---|----------------|--|-------------------|------------------------------|-------|
| | | | | Number of Lots | Failed Q'ty / Tested Q'ty | Notes |
| Accelerated Environment Stress Tests | Preconditioning Temperature Cycling : -55°C to 125°C Bake : 125°C Soak : 30°C, 60% RH Reflow : 260°C | JESD22-A113 | Level 3 5 cycles 24 hours 192 hours 3 cycles | 1 | 0 / 225 (Pass) | 1 |
| | Temperature & Humidity 85°C, 85% RH | JESD22-A101 | 504 hours | 1 | 0 / 75 (Pass) | 1, 2 |
| | Temperature Cycling -50°C to 125°C | JESD22-A104 | 1000 cycles | 1 | 0 / 75 (Pass) | 1, 2 |
| | Pressure Cooker Test 121°C, 100%RH, 2ATM | JESD22-A102 | 168 hours | 1 | 0 / 75 (Pass) | 1, 2 |
| | Low Temperature Storage Life -50°C | JESD22-A119 | 1008 hours | 1 | 0 / 75 (Pass) | 1 |
| | High Temperature Storage Life 150°C | JESD22-A103 | 1008 hours | 1 | 0 / 75 (Pass) | 1 |

Note :

1) Electrical test is performed before and after each item.

2) Preconditioning is performed before the test.



6. Electrical Verification Tests (Electrostatic Discharge & Latch-up)

| Group | Test Item / Conditions | Test Method | Duration or Level | Result | | |
|-------------------------------|--|----------------|----------------------|-------------------|------------------------------|-------|
| | | | | Number of Lots | Failed Q'ty / Tested Q'ty | Notes |
| Electrical Verification Tests | ESD Human Body Model | JESD22-A114 | 2000V | 1 | 0 / 9 (Pass) | 1, 2 |
| | ESD Charged Device Model | JESD22-C101 | 1000V | 1 | 0 / 3 (Pass) | 1, 2 |
| | Latch-Up (I-test) - Test at 105℃ | JESD78 | ±200mA | 1 | 0 / 6 (Pass) | 1 |
| | Latch-Up (Overvoltage) - Test at 105°C | | 3V | 1 | 0 / 3 (Pass) | 1, 3 |
| | | | | | | |

Note :

1) All electrical tests at different temperatures are performed before and after each item.

2) HBM & CDM tests are performed at room temp.

3) 3V is applied for VDD/VDDQ.